AMENDMENTS TO THE CLAIMS

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This listing of claims will replace all prior versions, and listing of claims in the application:

Claim 1 (currently amended): A holder for [[a]] an electronic module for connection to a eircuit in printed circuit board in an electronic equipment, the holder being arranged to receive the electronic module and having a portion provided with at least one hole therethrough,

wherein [[the]] at least one hole is arranged to provide access through the holder to the eireuit printed circuit board for testing[[.]]; and

the holder is further provided with a conductive layer on a surface for positioning adjacent the printed circuitry board.

Claim 2 (original): The holder of claim 1 wherein the at least one hole is arranged to be covered by the electronic module when positioned in the holder.

Claim 3 (currently amended): The holder of claim 1 [[or 2]] wherein the holder is provided with a plurality of holes therethrough.

Claim 4 (currently amended): The holder of claim <u>1</u> 1, 2 or 3 wherein the holder is arranged to be mounted on the <u>printed circuitry board eircuit</u> by one of <u>A or B, wherein:</u> [[A-B:]]

A comprises surface mount technology, and

B $\underline{\text{comprises}}$ plated through hole technology.

Claim 5 (canceled)

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Claim 6 (currently amended): The holder of any preceding claim 1 wherein the electronic module comprises a subscriber identification module.

Claim 7 (currently amended): The holder of any preceding claim 1 wherein the electronic equipment comprises wireless communication equipment.

Claim 8 (currently amended): The holder of any preceding claim 7 wherein the wireless communication equipment comprises a portable modem.

Claim 9 (canceled)

Claim 10 (currently amended): The holder of any preceding claim 1 wherein the holder is of moulded plastics material.

Claim 11 (currently amended): A method of assembling a holder for [[a]] <u>an electronic</u> module on a <u>eircuit for printed circuit board in an</u> electronic equipment, the method comprising:

providing a circuit the printed circuit board;

providing a holder for [[a]] the electronic module for connection mounting to the eircuit printed circuit board, the holder being arranged to receive the electronic module and having a portion provided with at least one hole to provide access through the holder of the printed circuit board for testing purposes;

providing the holder with a conductive layer on a surface for positioning adjacent the printed circuit board therethrough; and

mounting the holder on the circuit printed circuit board.

Claim 12 (currently amended):

electronic module in the holder such that the at least one hole is covered by the electronic module.

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Claim 13 (currently amended): The method of claim 11 [[or 12]] wherein the holder is provided with a plurality of holes therethrough.

Claim 14 (currently amended): The method of claim 11 11, 12 or 13 wherein the step of mounting comprises mounting the <u>electronic</u> module on the <u>eireuit printed circuit board</u> by one of A or B, wherein: [[A-B:]]

A comprises surface mount technology, and

B comprises plated through hole technology.

Claim 15 (canceled)

Claim 16 (currently amended): The method of any one of claims 11-15 claim 11 wherein the electronic module comprises a subscriber indentification identification module.

Claim 17 (currently amended): The method of any one of claims 11-16 claim 11 wherein the electronic equipment comprises wireless communication equipment.

Claim 18 (currently amended): The method of any one of claims 11 17 claim 17 wherein the wireless communication equipment comprises a portable modem.

Claim 19 (cancelled)

Claim 20 (currently amended): The method of any preceding claim <u>11</u> wherein the holder is moulded of plastics material.

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Claim 21 (cancelled)

Claim 22 (currently amended):

An electronic circuit having mounted thereon the holder of any

one of claims 1-10 claim 1.

Claim 23 (cancelled)

Claim 24 (cancelled)